

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5758875

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TIANYANG BAI	09/20/2019
JUNYI LI	09/25/2019
KIRAN VENUGOPAL	09/25/2019
JUNG HO RYU	09/26/2019
MAKESH PRAVIN JOHN WILSON	09/25/2019
TAO LUO	09/20/2019
YAN ZHOU	09/20/2019
RECEIVING PARTY DATA	
Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714
PROPERTY NUMBERS Total: 2	
Property Type	Number
Application Number:	16535637
Application Number:	62728545
CORRESPONDENCE DATA	
Fax Number:	(303)473-2720
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	303-473-2700
Email:	bmsouares@hollandhart.com
Correspondent Name:	MICHAEL DRAPKIN
Address Line 1:	P.O. BOX 11583
Address Line 4:	SALT LAKE CITY, UTAH 84147
ATTORNEY DOCKET NUMBER:	PR090.01 (103038.0474)
NAME OF SUBMITTER:	MICHAEL L. DRAPKIN
SIGNATURE:	/Michael L. Drapkin/

DATE SIGNED:	10/08/2019
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Total Attachments: 4
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ASSIGNMENT

WHEREAS, WE,

1. Tianyang BAI, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121-1714,
2. Junyi LI, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121-1714,
3. Kiran VENUGOPAL, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121-1714,
4. Jung Ho RYU, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121-1714,
5. Makesh Pravin JOHN WILSON, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121-1714,
6. Tao LUO, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121-1714,
7. Yan ZHOU, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121-1714,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **BEAM DETERMINATION TECHNIQUES IN BEAMFORMED WIRELESS COMMUNICATIONS** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that I/WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No. 16/535,637 filed August 8, 2019, Qualcomm

Reference No. 184969, and all provisional applications relating thereto, together with U.S. Provisional Application No. 62/728,545 filed September 7, 2018, Qualcomm Reference No. 184969P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at Bridgewater, NJ, on 9.20.2019
LOCATION DATE
Tianyang Bai
Tianyang BAI

Done at Bridgewater, NJ, on 9.25.2019
LOCATION DATE
Junyi Li
Junyi Li

Done at Bridgewater, NJ, on 9.25.2019
LOCATION DATE
Kiran Venugopal
Kiran VENUGOPAL

Done at Bridgewater, NJ, on 9.26.2019
LOCATION DATE
Jung Ho Ryu
Jung Ho RYU

Done at _____, on _____
LOCATION DATE
Makesh Pravin JOHN WILSON

Done at _____, on _____
LOCATION DATE
Tao LEO

Done at _____, on _____
LOCATION DATE
Yan ZHOU


AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
LOCATION DATE Tianyang BAI

Done at _____, on _____
LOCATION DATE Junyi LI

Done at _____, on _____
LOCATION DATE Kiran VENUGOPAL

Done at _____, on _____
LOCATION DATE Jung Ho RYU

Done at San Diego, CA, on 09/25/2019
LOCATION DATE 
Makesh Pravin JOHN WILSON

Done at Sunnyvale, CA, on 09/20/2019
LOCATION DATE 
Tao LUO

Done at Sunnyvale, CA, on 09/20/2019
LOCATION DATE 
Ysa ZHOU